

PRODUCT/PROCESS CHANGE NOTICE (PCN)					
PCN Number: PCN 22001 Date Issued: 1/26/2022 Product(s) Affected:				Means of Distinguishing Changed Devices: Product Mark:	
SP485ECN-L SP485ECN-L/TR	SP485EEN-L SP485EEN-L/TR	SP485EMN-L/TR		☐ Back Mark ☐ Date Code ☐ Other: Lot number	
Manufacturing Location Affected: Wafer Foundry: Key Foundry Date Effective (90 day window): January 26, 2022 Date Issued +90 days: April 26, 2022					
Contact: Your local MaxLinear Marketing Representative or contact our Customer Support team by creating a				chment: 🗌 Yes 🔀 No	
Support Ticket at http://www.maxlinear.com/support/createcase Phone: 1-760-692-0711				ples: Request from x Linear Marketing presentatives	
Description and Purpose of Change: MaxLinear has qualified Key Foundry wafer foundry in order to increase production capacity and to facilitate long term support of the product line. The wafer process is 0.18um BCD. The process has been optimized to produce very similar product characteristics as the currently shipping devices from TSMC foundry and will meet existing datasheet specifications. There are no changes in device reliability Note: Users who rely on DC, diode characteristics during ICT testing should take caution certain I/O characteristics may appear changed due to the proprietary I/O structures employed by Key Foundry. These DC / diode characteristic differences are not guaranteed nor required to ensure full design functionality per datasheet. Adjustments at ICT testing may be required to prevent false failures.				Die Technology Wafer Fabrication Assembly Process Equipment Material Testing Product Desing Manufacturing Site Data Sheet Yield Enhancement Software Other:	
Reliability/Qualification Summary:					
Customer Acknowledgement of Rec Please fax or email this form to the		_	•	onstitutes acceptance of change.	
Customer:	N	lame:			
Title: Date:					
E-Mail:	P	hone:			
Fax:					
Approval for shipments prior to Customer Comments (Optional):	effective date				